

# N-Channel 40-V (D-S), 175 °C MOSFET

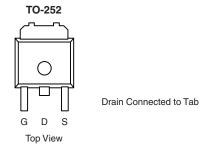
PRODUCT SUMMARY					
V <sub>(BR)DSS</sub> (V)	$r_{DS(on)}$ ( $\Omega$ )	I <sub>D</sub> (A) <sup>c</sup>	Q <sub>g</sub> (Typ)		
40	0.006 at V <sub>GS</sub> = 10 V	109	95		

#### **FEATURES**

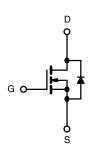
- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- · High Threshold Voltage At High Temperature







Ordering Information: SUD50N04-06H-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A =$	= 25 °C, unless othe	rwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	40	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current (T, = 175 °C)	T <sub>C</sub> = 25 °C	L	109 <sup>c</sup>		
Continuous Diain Current (1) = 173 C)	T <sub>C</sub> = 100 °C	l <sub>D</sub>	77 <sup>c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub> 100			
Avalanche Current (Single Pulse)					
Repetitive Avalanche Energy (Single Pulse) <sup>a</sup> L = 0.1		E <sub>AS</sub>	125	mJ	
Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	136	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Lucation to Auchienth	t ≤ 10 sec	R <sub>thJA</sub>	15	18	°C/W
Junction-to-Ambient <sup>b</sup>	Steady State		40	50	
Junction-to-Case		R <sub>thJC</sub>	0.85	1.1	

#### Notes:

- a. Duty cycle  $\leq$  1 %.
- b. Surface Mounted on 1" FR4 board.
- c. Based on maximum allowable Junction Temperature. Package limitation current is 50 A.

## SUD50N04-06H

## Vishay Siliconix



<b>SPECIFICATIONS</b> $T_J = 25$	°C, unless	otherwise noted					
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static				•			
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.4		5.0		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1		
	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	μΑ	
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			150	1	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0049	0.006	Ω	
	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C			0.009		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C			0.012		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	20	50		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			6700		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		600			
Reversen Transfer Capacitance	C <sub>rss</sub>			320			
Total Gate Charge <sup>c</sup>	Qg			95			
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		37		nC	
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			21			
Gate Resistance	R <sub>g</sub>	f = 1.0 MHz		1.7		Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			20	30		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 0.4 $\Omega$ $I_D$ $\cong$ 50 A, $V_{GEN}$ = 10 V, $R_g$ = 2.5 $\Omega$		95	145	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			50	75		
Fall Time <sup>c</sup>	t <sub>f</sub>			12	20		
Source-Drain Diode Ratings and Cha	aracteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>					
Continuous Current	Is				50	^	
Pulsed Current	I <sub>SM</sub>				100	Α	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 30 A, V <sub>GS</sub> = 0 V		0.90	1.50	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 30 A, di/dt = 100 A/μs		40	60	ns	

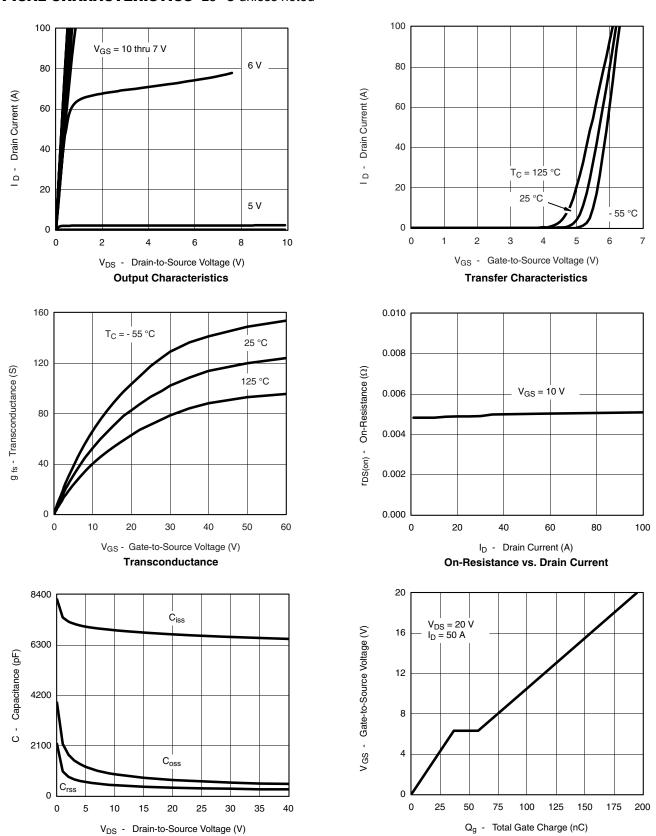
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### TYPICAL CHARACTERISTICS 25 °C unless noted



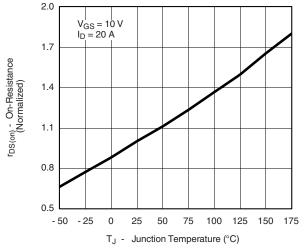
Capacitance

**Gate Charge** 

# Vishay Siliconix

# VISHAY.

## TYPICAL CHARACTERISTICS 25 °C unless noted

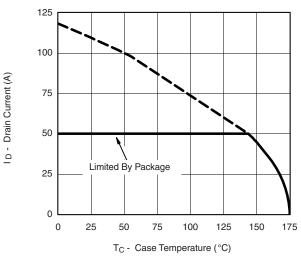


T<sub>J</sub> = 150 °C

T<sub>J</sub> = 25 °C

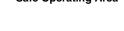


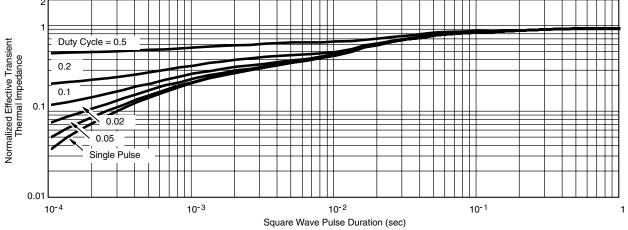
#### THERMAL RATINGS



1000 by r<sub>DS(on)</sub> 10 μs 100 100 μs 1<sub>D</sub> - Drain Current (A) 1 ms 10 10 ms dc, 100 ms  $T_C = 25$  °C Single Pulse 0.1 0.1 100 V<sub>DS</sub> -Drain-to-Source Voltage (V)  $^*V_{GS}$  > minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified Safe Operating Area

Maximum Avalanche and Drain Current vs. Case Temperature





Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?72860">http://www.vishay.com/ppg?72860</a>.



Vishay

## **Disclaimer**

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 Revision: 18-Jul-08

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

SUD50N04-06H-E3